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Full bridge control IC for HID automotive lighting

Rev. 01 — 30 October 2008

Product data sheet

1. General description

The UBA2036 is a high voltage monolithic Integrated Circuit (IC) manufactured in a High Voltage Silicon On Insulator (HVSOI) process. This circuit is designed for driving MOSFETs in a full bridge configuration. In addition, it features a disable function, an internal adjustable oscillator and an external clock input function with a high-voltage level shifter for driving the bridge. To guarantee an accurate 50 % duty cycle, the oscillator signal can be passed through a divider before being fed to the output drivers.

The UBA2036 is especially suitable for High Intensity Discharge (HID) lamp drivers for car headlights, projectors and general lighting applications.

2. Features

- Full bridge driver circuit
- Integrated bootstrap diodes
- 464 V integrated high voltage level shift function to drive HID lamps below ground level
- 550 V series regulator input to make the internal supply
- 550 V maximum bridge voltage
- Accurate bridge disable function
- Input for start-up delay
- Adjustable oscillator frequency
- Selectable frequency divider
- Predefined bridge position during start-up
- Adaptive non-overlap

3. Applications

- The UBA2036 can drive (via the power MOSFETs) any kind of load in a full bridge configuration
- The circuit is especially designed as a commutator controller for HID lamps in car headlights, projectors and general lighting applications

4. Ordering information

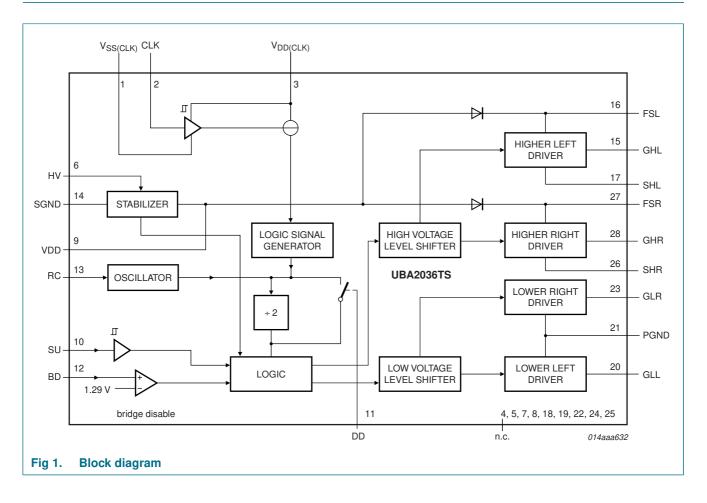
Table 1.Ordering information

Type number	er Package					
	Name	Description	Version			
UBA2036TS	SSOP28	plastic shrink small outline package; 28 leads; body width 5.3 mm	SOT341-1			



Full bridge control IC for HID automotive lighting

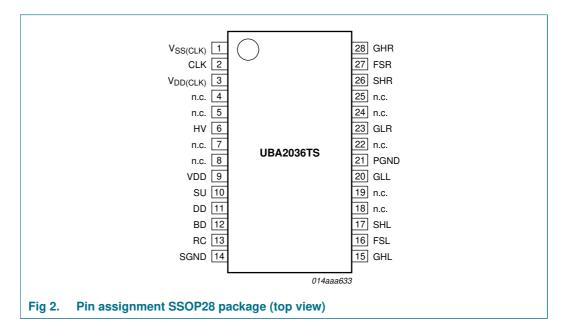
5. Block diagram



Full bridge control IC for HID automotive lighting

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
V _{SS(CLK)}	1	negative supply voltage for logic oscillator input
CLK	2	oscillator input
V _{DD(CLK)}	3	positive supply voltage for logic oscillator input
n.c.	4	not connected
n.c.	5	not connected
HV	6	high voltage supply input for internal series regulator
n.c.	7	not connected
n.c.	8	not connected
VDD	9	internal low voltage supply
SU	10	input for start-up delay
DD	11	input for divider disable
BD	12	input for bridge disable
RC	13	RC input for internal oscillator
SGND	14	signal ground
GHL	15	gate driver output for upper left MOSFET
FSL	16	floating supply left
SHL	17	source upper left MOSFET
n.c.	18	not connected
n.c.	19	not connected

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Full bridge control IC for HID automotive lighting

Table 2.	Pin description .	continued
Symbol	Pin	Description
GLL	20	gate driver output for lower left MOSFET
PGND	21	power ground
n.c.	22	not connected
GLR	23	gate driver output for lower right MOSFET
n.c.	24	not connected
n.c.	25	not connected
SHR	26	source upper right MOSFET
FSR	27	floating supply right
GHR	28	gate driver upper right MOSFET

7. Functional description

7.1 Supply voltage

The UBA2036 is powered by a supply voltage applied to pin HV, e.g. the supply voltage of the full bridge. The IC generates its own low supply voltage for its internal circuitry. Therefore an additional low voltage supply is not required. A capacitor has to be connected to pin VDD to obtain a ripple-free internal supply voltage. The circuit can also be powered by a low voltage supply directly applied to pin VDD. In this case pin HV should be connected to pin VDD or pin SGND. The maximum current that the internal series regulator can deliver, is temperature dependent. This is shown in Figure 3.

7.2 Start-up

With an increasing supply voltage the IC enters the start-up state i.e. the upper power transistors are set in off-state and the lower power transistors are switched on. During the start-up state the bootstrap capacitors are charged. The start-up state is defined until $V_{VDD} = V_{startup(VDD)}$ or $V_{HV} = V_{startup(HV)}$. The state of the outputs during the start-up phase is overruled by the bridge disable function.

7.3 Oscillation state

At the moment the supply voltage on pin VDD exceeds $V_{startup(VDD)}$ or the supply voltage on pin V_{HV} exceeds $V_{startup(HV)}$, the output voltage of the full bridge depends on the control signals on pins CLK, SU, DD and BD. This is listed in <u>Table 3</u>.

As soon as the supply voltage on pin VDD becomes lower than $V_{UVLO(VDD)}$ or the supply voltage on pin V_{HV} becomes lower than $V_{UVLO(HV)}$, the IC enters the start-up state again.

Table 3.Gate driver	Drive outpu	-	ages a	s function	of the logical	levels at the p	ins BD, SU, DD	and CLK.
Device state	BD	SU	DD	CLK	GHL	GHR	GLL	GLR
Start-up	1	-	-	-	$0 (= V_{SHL})$	$0 (= V_{SHR})$	$0 (= V_{PGND})$	$0 (= V_{PGND})$
state	0	-	-	-	0 (= V _{SHL})	0 (= V _{SHR})	1 (= V _{VDD})	1 (= V _{VDD})

Full bridge control IC for HID automotive lighting

Device state	BD	SU	DD	CLK	GHL	GHR	GLL	GLR
Oscillation state	1	-	-	-	$0 (= V_{SHL})$	$0 (= V_{SHR})$	$0 (= V_{PGND})$	$0 (= V_{PGND})$
	0	0	-	-	$0 (= V_{SHL})$	$0 (= V_{SHR})$	1 (= V _{VDD})	$1 (= V_{VDD})$
	0	1	1	1	$0 (= V_{SHL})$	1 (= V _{FSR})	1 (= V _{VDD})	$0 (= V_{PGND})$
	0	1	1	0	1 (= V _{FSL})	$0 (= V_{SHR})$	$0 (= V_{PGND})$	1 (= V _{VDD})
	0	1	0[1]	$1 \rightarrow 0^{[2]}$	GHL	GHR	GLL	GLR

Table 3.Driver ...continued

[1] If pin DD = 0 the bridge enters the state (oscillation state and pin BD = 0 and pin SU = 1) in the pre-defined position: V_{GHL} = V_{FSL}, V_{GLR} = V_{VDD}, V_{GLL} = V_{PGND}, and V_{GHR} = V_{SHR}.

[2] Only if the level of pin CLK changes from logical 1 to 0, the level of outputs GHL, GHR, GLL and GLR changes.

If there is no external clock available, the internal oscillator can be used. The design equation for the bridge oscillator frequency is shown in Equation 1.

$$f_{bridge} = \frac{1}{K_{osc} \times R_{osc} \times C_{osc}}$$
(1)

 R_{osc} and C_{osc} are external components connected to the RC pin (R_{osc} connected to pin VDD and C_{osc} connected to pin SGND). In this situation the pins $V_{DD(CLK)}$, CLK and $V_{SS(CLK)}$ can be connected to SGND.

The clock signal, coming from either pin RC or pin CLK, is divided by two in order to obtain a 50 % duty-cycle gate drive signal. This can be achieved by applying a voltage to the DD input lower than $V_{IL(DD)}$ (e.g. connect pin DD to pin SGND).

7.4 Non-overlap time

In the full bridge configuration the non-overlap time is defined as the time between turning off the two conducting MOSFETs and turning on the two other MOSFETs. The non-overlap time is realized by means of an adaptive non-overlap circuit. With an adaptive non-overlap, the application determines the duration of the non-overlap and makes the non-overlap time optimal for each frequency. The non-overlap time is determined by the duration of the falling slope of the relevant half bridge voltage. The occurrence of a slope is sensed internally. The minimum non-overlap time is internally fixed.

7.5 Start-up delay

A simple resistor-capacitor (RC) filter (R between pin VDD and pin SU; C between pin SU and pin SGND) or a control signal from a processor can be used to make a start-up delay. This can be beneficial for those applications in which building up the high voltage takes a larger amount of time: A start-up delay will ensure that the HID system will not start up before this high voltage has been reached.

7.6 Bridge disable

The bridge disable function can be used to switch off all the MOSFETs as soon as the voltage on pin BD exceeds the bridge disable voltage V_{BD} . The bridge disable function overrules all the other states.

Full bridge control IC for HID automotive lighting

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to signal ground (pin 14); positive currents flow into the chip. The voltage ratings are valid provided other ratings are not violated.

General -40 +125 T _{mb} ambient temperature -40 +125 T _j junction temperature -40 +150 Voltages voltage on pin VDD DC 0 14 maximum pulse time = 100 ns 0 17 V _{VDD} voltage on pin VDD DC 0 14 maximum pulse time = 100 ns 0 17 V _{VDD} voltage on pin HV 0 550 V _{SHL} voltage on pin SHL with respect to SGND; maximum pulse time = 1 µs -14 550 V _{SHR} voltage on pin SHR with respect to SGND; maximum pulse time = 1 µs -14 550 V _{FSL} voltage on pin FSL with respect to SGND; maximum pulse time = 1 µs -14 550 V _{FSR} voltage on pin GHL VSHL 0 14 V _{GHR} voltage on pin GHL VSHL VSHL VSHL V _{GLL} voltage on pin GLR VFSR VSHL VSHL V _{GLL} voltage on pin GLR VFSR VPOD 464 V _{DDL} CLK ground supply voltage t < 1 s 0 14 Maximum pulse time = 100 ns 0 17 17 V _{RAN} pin RC: maximum pulse tim	Mi	Conditions	Min	Max	Unit
Tj junction temperature -40 +150 Tsig storage temperature -55 +150 Voltages maximum pulse time = 100 ns 0 14 Vypp voltage on pin VDD DC 0 14 maximum pulse time = 100 ns 0 17 Vytv voltage on pin HV 50 550 VsHL voltage on pin SHL with respect to SGND; maximum pulse time = 1 µs -14 550 VsHR voltage on pin FSL with respect to SGND; maximum pulse time = 1 µs -14 550 VsHR voltage on pin FSL with respect to SGND; maximum pulse time = 1 µs -14 550 VsHL voltage on pin FSL with respect to SGND; maximum pulse time = 1 µs -14 550 VsHL voltage on pin GHL voltage NSH 0 14 VgHL voltage on pin GHR VsHK VsHK VsHK VgHR voltage on pin GLR VsHK VsHK VsHK VgLL voltage on pin GLR VsHK VsHK VsHK					
Tatgstorage temperature-55+150VotagesVvDDDC014maximum pulse time = 100 ns017VHVvoltage on pin HV0550VSHLvoltage on pin SHLwith respect to PGND and SGND-3550WSHRvoltage on pin SHLwith respect to SGND; maximum pulse time = 1 µs-14550VSHRvoltage on pin SHRwith respect to SGND; maximum pulse time = 1 µs-14550VSHRvoltage on pin FSLwith respect to SGND; maximum pulse time = 1 µs-14550VFSLvoltage on pin FSLwith respect to SHL014VGHLvoltage on pin GLLVSHLVSHLVSHLVGALvoltage on pin GLLVPGNDVoDVoDVagRRvoltage on pin GLLVPGNDVoDVoDVGRLQVoltage on pin GLLVPGNDVoD5VSIGLKICLK ground supply voltaget < 1 s	-4		-40	+125	°C
Voltages V Voltage on pin VDD DC 0 14 maximum pulse time = 100 ns 0 17 V _{HV} voltage on pin HV 0 550 V _{SHL} voltage on pin SHL with respect to PGND and SGND -3 550 with respect to SGND; maximum pulse time = 1 μs -14 550 V _{SHR} voltage on pin SHR with respect to SGND; maximum pulse time = 1 μs -14 550 V _{SHR} voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs -14 550 V _{FSL} voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs 0 14 V _{FSR} voltage on pin GRL V _{SHR} 0 14 V _{GHR} voltage on pin GLL V _{SHR} V _{SHR} V _{SHR} V _{GLL} voltage on pin GLR V _{PGND} V _{VDD} V _{PGND} V _{PGND} V _{GLR} voltage on pin GLR V _{PGND} V _{PGND} V _{PGND} V _{PGND} V _{DICLKO} CLK supply voltage t < 1 s	-4		-40	+150	°C
VyDDvoltage on pin VDDDC014maximum pulse time = 100 ns017VHVvoltage on pin HV0550VSHLvoltage on pin SHLwith respect to PGND and SGND-3550with respect to SGND; maximum pulse time = 1 µs-14550VSHRvoltage on pin SHRwith respect to PGND and SGND-3550WFSLvoltage on pin FSLwith respect to PGND and SGND-3550VFSLvoltage on pin FSLwith respect to SGND; maximum pulse time = 1 µs-14550VFSLvoltage on pin GHL014VGHRvoltage on pin GHLVSHRVSHRVFSLVGHRvoltage on pin GHLVSHRVFSRVFSRVGLLvoltage on pin GHLVPGNDVVDDVPGNDVGLRvoltage on pin GLVPGNDVVDDVPGNDVGLRvoltage on pin GLVPGNDVVDDVPGNDVGLRvoltage on pin GLVPGNDVPGNDVDDVGLRvoltage on pin GLVPGNDVPGNDVDDVGLRvoltage on pin GLVPGNDVPGNDVPGNDVDCCLK)CLK supply voltaget < 1 s	-5		-55	+150	°C
Maximum pulse time = 100 ns017 V_{HV} voltage on pin HV0550 V_{SHL} voltage on pin SHLwith respect to PGND and SGND-3550with respect to SGND; maximum pulse time = 1 µs-14550 V_{SHR} voltage on pin SHRwith respect to PGND and SGND-3550 V_{SHL} voltage on pin SHRwith respect to SGND; maximum pulse time = 1 µs-14550 V_{FSL} voltage on pin FSLwith respect to SGND; maximum pulse time = 1 µs-14550 V_{FSL} voltage on pin FSRwith respect to SHR014 V_{FSR} voltage on pin GHL V_{SHL} V_{SHL} V_{FSL} V_{GLL} voltage on pin GHR V_{SHR} V_{FSR} V_{SHR} V_{FSR} V_{GLL} voltage on pin GLR V_{PGND} V_{VDD} V_{VDD} V_{VDD} V_{GLQ} CLK ground supply voltaget < 1 s					
VHVvoltage on pin HV0550VSHLvoltage on pin SHLwith respect to PGND and SGND-3550with respect to SGND; maximum pulse time = 1 µs-14550VSHRvoltage on pin SHRwith respect to SGND; maximum pulse time = 1 µs-14550VFSLvoltage on pin FSLwith respect to SGND; maximum pulse time = 1 µs-14550VFSLvoltage on pin FSLwith respect to SGND; maximum pulse time = 1 µs-14550VFSLvoltage on pin FSLwith respect to SHR014VGHLvoltage on pin GHLVSHLVFSLVFSLVGLLvoltage on pin GHLVSHRVFSRVFSNVGLLvoltage on pin GLRVPGNDVvDDVvDDVGLRvoltage on pin GLRVFSNVFSNVVDDVPGNDvoltage on pin GLRVFSNVFSNVFSNVDD(CLK)CLK ground supply voltaget <1 s	0	00	0	14	V
VSHL voltage on pin SHL with respect to PGND and SGND -3 550 VSHR voltage on pin SHR with respect to SGND; maximum pulse time = 1 μs -14 550 VSHR voltage on pin SHR with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SHL 0 14 VFSR voltage on pin GHL VSHR VFSL VFSL VGLL voltage on pin GLL VSHR VFSR VFSR VGLR voltage on pin GRD 0 55 VSS(CLK) CLK ground supply voltage t < 1 s	0	naximum pulse time = 100 ns	0	17	V
with respect to SGND; maximum pulse time = 1 μs -14 550 VSHR voltage on pin SHR with respect to PGND and SGND -3 550 with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SGND; maximum pulse time = 1 μs 0 14 VFSR voltage on pin FSR with respect to SHR 0 14 VGHL voltage on pin GHL VSHR VFSR VGLL voltage on pin GL VFSR VFSR VGLR voltage on pin GLR VPGND VDD VFSICL(K) CLK ground supply voltage t < 1 s	0		0	550	V
maximum pulse time = 1 μs maximum pulse time = 1 μs 550 VSHR voltage on pin SHR with respect to SGND; maximum pulse time = 1 μs -14 550 VFSL voltage on pin FSL with respect to SHL 0 14 VFSR voltage on pin FSR with respect to SHR 0 14 VGHL voltage on pin GHL VSHL VSHL VFSL VGLL voltage on pin GHR VsHL VFSR VFSR VGLL voltage on pin GLL VSHR VFSR VFSR VGLR voltage on pin GLR VPGND VVDD VFGND VVDD VGRND voltage on pin PGND 0 5 5 VSS(CLK) CLK ground supply voltage t < 1 s	-3	with respect to PGND and SGND	-3	550	V
with respect to SGND; maximum pulse time = 1 μ s-14550VFSLvoltage on pin FSLwith respect to SHL014VFSRvoltage on pin FSRwith respect to SHR014VGHLvoltage on pin GHLVSHLVFSLVFSLVGHRvoltage on pin GHRVSHRVFSRVvDDVGLLvoltage on pin GLRVPGNDVvDDVvDDVGLRvoltage on pin GLRVPGNDVVDDVVDDVSS(CLK)CLK ground supply voltaget < 1 s	-1	•	-14	550	V
Maximum pulse time = 1 μs maximum pulse time = 1 μs VFSL voltage on pin FSL with respect to SHL 0 14 VFSR voltage on pin FSR with respect to SHR 0 14 VGHL voltage on pin GHL VSHL VFSR VFSR VGHR voltage on pin GHR VsHR VFSR VFSR VGLL voltage on pin GLR VpGND VpGND VvDD VSGLK voltage on pin PGND 0 464 VSS(CLK) CLK ground supply voltage t < 1 s	-3	with respect to PGND and SGND	-3	550	V
$V_{FSR} voltage on pin FSR with respect to SHR 0 14 \\ V_{GHL} voltage on pin GHL V_{SHL} V_{FSL} \\ V_{GHR} voltage on pin GHR V_{SHR} V_{FSR} \\ V_{GLL} voltage on pin GLR V_{PGND} V_{VDD} \\ V_{GLR} voltage on pin GLR V_{PGND} V_{VDD} \\ V_{PGND} voltage on pin PGND 0 5 \\ V_{SS(CLK)} CLK ground supply voltage t < 1 s 0 464 \\ with respect to V_{SS(CLK)}: DC 0 14 \\ maximum pulse time = 100 ns 0 17 \\ Pin RC: \\ maximum pulse time = 100 ns 0 17 \\ Pin RC: \\ maximum pulse time = 100 ns 0 17 \\ Pin SHL and SHR - 6 \\ pin V_{SS(CLK)} - 0.5 \\ Currents \\ V_{Currents} $	-1		-14	550	V
VGHL voltage on pin GHL V _{SHL} V _{FSL} V _{FSL} VGHR voltage on pin GHR V _{SHR} V _{SHR} V _{FSR} VGLL voltage on pin GLL V _{PGND} V _{vDD} V _{vDD} VGLR voltage on pin GLR V _{PGND} V _{vDD} V _{vDD} V _{GIND} voltage on pin PGND 0 5 V _{SS(CLK)} CLK ground supply voltage t < 1 s	0	with respect to SHL	0	14	V
VGHR voltage on pin GHR VSHR VFSR VGLL voltage on pin GLL VPGND VPGND VvDD VGLR voltage on pin GLR VPGND VvDD VvDD VPGND voltage on pin PGND 0 5 VSS(CLK) CLK ground supply voltage t < 1 s	0	with respect to SHR	0	14	V
VGLL voltage on pin GLR VPGND VVDD VGLR voltage on pin GLR VPGND VPGND VVDD VPGND voltage on pin PGND 0 5 VSS(CLK) CLK ground supply voltage t < 1 s	Vs		V_{SHL}	V_{FSL}	V
VGLR voltage on pin GLR VPGND VVDD VPGND voltage on pin PGND 0 5 VSS(CLK) CLK ground supply voltage t < 1 s	Vs		V_{SHR}	V_{FSR}	V
VPGND voltage on pin PGND 0 5 VSS(CLK) CLK ground supply voltage t < 1 s	VP		V _{PGND}	V_{VDD}	V
VSS(CLK) CLK ground supply voltage t < 1 s 0 464 VDD(CLK) CLK supply voltage t < 1 s	VP		V _{PGND}	V_{VDD}	V
VDD(CLK) CLK supply voltage t < 1 s 0 464 with respect to V _{SS(CLK)} : DC 0 14 maximum pulse time = 100 ns 0 17 VI input voltage pins CLK, SU, BD, and DD; with respect to V _{SS(CLK)} : DC 0 VvDD DC 0 17 DC 0 17 VI input voltage pins CLK, SU, BD, and DD; with respect to V _{SS(CLK)} : DC 0 VvDD maximum pulse time = 100 ns 0 17 pin RC: T maximum pulse time = 100 ns 0 17 SR slew rate pins SHL and SHR - 6 pin V _{SS(CLK)} - 0.5	0		0	5	V
$\begin{tabular}{ c c c c } \hline V_{V,V} & V_{V,$	0	< 1 s	0	464	V
$\begin{tabular}{ c c c c }\hline DC & 0 & 14 \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline maximum pulse time = 100 ns & 0 & V_{VDD} \\ \hline DC & 0 & V_{VDD} \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin RC: & & & & \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin RC: & & & & \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin SHL and SHR & - & 6 \\ \hline pin V_{SS(CLK)} & - & 0.5 \\ \hline \end{tabular}$	0	< 1 s	0	464	V
$\begin{tabular}{ c c c c c } \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline maximum pulse time = 100 ns & V_{SS(CLK)}: & \hline DC & 0 & V_{VDD} \\ \hline DC & 0 & V_{VDD} \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin RC: & & & & \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin SR & slew rate & $$pins SHL and SHR & - $$ 6$ \\ \hline pin V_{SS(CLK)} & - $$ 0.5 \\ \hline \end{tabular}$		with respect to V _{SS(CLK)} :			
VI input voltage pins CLK, SU, BD, and DD; with respect to $V_{SS(CLK)}$: DC 0 V_{VDD} maximum pulse time = 100 ns 0 17 pin RC: maximum pulse time = 100 ns 0 17 SR slew rate pins SHL and SHR - 6 pin $V_{SS(CLK)}$ - 0.5	0	DC	0	14	V
$\begin{tabular}{ c c c c } \hline DC & 0 & V_{VDD} \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline pin RC: & & & & \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline SR & slew rate & & & \\ \hline pin SHL and SHR & - & 6 \\ \hline pin V_{SS(CLK)} & - & 0.5 \\ \hline \end{tabular}$	0	maximum pulse time = 100 ns	0	17	V
maximum pulse time = 100 ns 0 17 pin RC:	to Vs	pins CLK, SU, BD, and DD; with resp	to V _{SS(CLK)}):	
$\frac{\text{pin RC:}}{\text{maximum pulse time = 100 ns}} 0 17$ SR slew rate $\frac{\text{pins SHL and SHR}}{\text{pin V}_{SS(CLK)}} - 6$ Currents	0	DC	0	V_{VDD}	V
$\begin{tabular}{ c c c c c c } \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline maximum pulse time = 100 ns & 0 & 17 \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	0	maximum pulse time = 100 ns	0	17	V
SR slew rate pins SHL and SHR - 6 pin V _{SS(CLK)} - 0.5 Currents		bin RC:			
pin V _{SS(CLK)} - 0.5	0	maximum pulse time = 100 ns	0	17	V
Currents	-	bins SHL and SHR	-	6	V/ns
	-	bin V _{SS(CLK)}	-	0.5	V/μs
P accellator resistance connected between size VDD and 100					
R _{osc} oscillator resistance connected between pins VDD and 100 - RC	10	connected between pins VDD and RC	100	-	kΩ

Full bridge control IC for HID automotive lighting

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to signal ground (pin 14); positive currents flow into the chip. The voltage ratings are valid provided other ratings are not violated.

Symbol	Parameter	Conditions	Min	Max	Unit
ESD					
V _{ESD}	electrostatic discharge voltage	human body model			
		HV, V _{SS(CLK)} , V _{DD(CLK)} ,CLK, FSL, FSR, GHL, GHR, SHL, SHR	-	900	V
		other pins	-	2	kV
		machine model; all pins	-	200	V
		charged device model; all pins	-	500	V

9. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	100	K/W

10. Characteristics

Table 6. Characteristics

 T_j = -40 °C to 125 °C; all voltages are measured with respect to signal ground (pin 14); currents are positive when flowing into the IC, Unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
High voltage						
l _{leak}	leakage current	pin HV; I_{HV} (V _{HV} = 565 V) – I_{HV} (V _{HV} = 500 V)	-	0	10	μA
		pin FSL; V _{FSL} = V _{SHL} = V _{GHL} = 564 V	-	0	5	μA
		pin FSR; V _{FSR} = V _{SHR} = V _{GHR} = 564 V	-	0	5	μA
		pin V _{SS(CLK)} ; V _{SS(CLK)} = V _{clk} = 450 V	-	0	10	μA
		$ \begin{array}{l} \mbox{pin } V_{DD(CLK)}; \\ V_{DD(CLK)} = V_{clk} = 464 \ V \end{array} $	-	0	10	μA
Start-up via HV	' pin					
I _{I(HV)}	input current on pin HV	$V_{HV} = 80 V$	-	590	825	μA
V _{startup(HV)}	start-up voltage on pin HV		11.3	13.2	14.7	V
V _{UVLO(HV)}	undervoltage lockout voltage on pin HV		8.6	10.7	12.2	V
V _{hys}	hysteresis voltage		2	2.5	3	V
V _{VDD}	voltage on pin VDD	V _{HV} = 20 V	10.5	12	13.5	V
Start-up via VD	D pin					
I _{I(VDD)}	input current on pin VDD	V _{VDD} = 8.25 V	-	500	800	μA
V _{startup(VDD)}	start-up voltage on pin VDD		8.25	9.0	9.75	V

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Table 6. Characteristics ...continued

 T_j = -40 °C to 125 °C; all voltages are measured with respect to signal ground (pin 14); currents are positive when flowing into the IC, Unless otherwise specified.

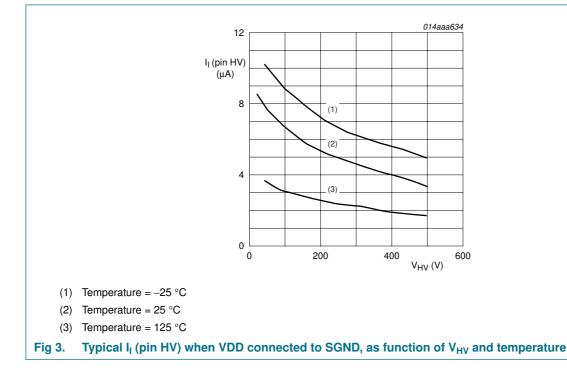
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{UVLO(VDD)}	undervoltage lockout voltage on pin VDD		5.75	6.5	7.25	V
V _{hys}	hysteresis voltage		2	2.5	3	V
Gate drivers						
R _{on}	on-state resistance	GHR and GHL drivers; $V_{FSL} = V_{FSR} = 12 V$; $V_{SHL} = V_{SHR} = 0 V$; $I_{GHL} = I_{GHR} = -50 mA$	-	20	42	Ω
		GLL and GLR drivers; V _{VDD} = 12 V; V _{PGND} = 0 V; I _{GLL} = I _{GLR} = -50 mA	-	20	42	Ω
R _{off}	off-state resistance	GHR and GHL drivers; $V_{FSL} = V_{FSR} = 12 V$; $V_{SHL} = V_{SHR} = 0 V$; $I_{GHL} = I_{GHR} = 50 mA$	-	12	26	Ω
		GLR and GLL drivers; V _{VDD} = 12 V; V _{PGND} = 0 V; I _{GLL} = I _{GLR} = 50 mA	-	12	26	Ω
I _{O(source)}	output source current		-	200	-	mA
I _{O(sink)}	output sink current		-	200	-	mA
V _{d(bs)}	bootstrap diode voltage	current on diode = 1 mA	0.8	1.0	1.2	V
dV/dt	rate of change of voltage	absolute values	5	15	25	V/µs
t _{no}	non-overlap time		600	900	1300	ns
V _{UVLO}	undervoltage lockout voltage	high side driver	-	4.0	5.5	V
I _{FS}	current on pin FS	$V_{FSL} = V_{FSR} = 12 V;$ $V_{SHL} = V_{SHR} = 0 V$	1	4	7	μA
I _{FSL} /I _{FSR}	current on pin FSL to current on pin FSR ratio		0.8	-	1.2	
DD input						
V _{IH(DD)}	HIGH-level input voltage on pin DD	$V_{VDD} = 12 V$	6	4.5	-	V
V _{IL(DD)}	LOW-level input voltage on pin DD	V _{VDD} = 12 V	-	-	3	V
I _I	input current	$V_{VDD} = 12 V$	-	0	1	μA
SU input						
V _{startup}	start-up voltage	V _{VDD} = 12 V	1	1.3	1.5	V
V _{hys}	hysteresis voltage	V _{VDD} = 12 V	-	100	-	mV
l _l	input current	$V_{VDD} = 12 V$	-	0	1	μA
CLK input						
V _{IH(CLK)}	HIGH-level input voltage on pin CLK	$V_{SS(CLK)} = 0 V; V_{DD(CLK)} = 12 V$	0.9	1.6	2.7	V
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Table 6. Characteristics ...continued

 $T_j = -40 \circ C$ to $125 \circ C$; all voltages are measured with respect to signal ground (pin 14); currents are positive when flowing into the IC, Unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{hys}	hysteresis voltage	$V_{SS(CLK)} = 0 V; V_{DD(CLK)} = 12 V$	-	100		mV
l _l	input current		-	0	1	μA
f _{bridge}	bridge frequency	V _{RC} = 0 V	-	-	200	kHz
supply for CLK						
I _{DD(CLK)}	CLK supply current	$V_{SS(CLK)} = 0 V; V_{DD(CLK)} = 14 V$	-	420	625	μA
V _{DD(CLK)}	CLK supply voltage	$V_{SS(CLK)} = 0 V$	5.75	-	14	V
BD input						
V _{BD}	voltage on pin BD		1.23	1.29	1.35	V
I _I	input current		-	0	1	μA
Internal oscillato	or					
f _{osc(int)}	internal oscillator frequency	$V_{CLK} = 0 V; V_{SS(CLK)} = 0 V$	-	-	100	kHz
K _{osc}	oscillator constant	f _{bridge} = 500 Hz	0.89	0.97	1.05	



11. Quality information

This product has been qualified to the appropriate Automotive Electronics Council (AEC) standard Q100 and Q101 and is suitable for use in automotive critical applications.

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12. Package outline

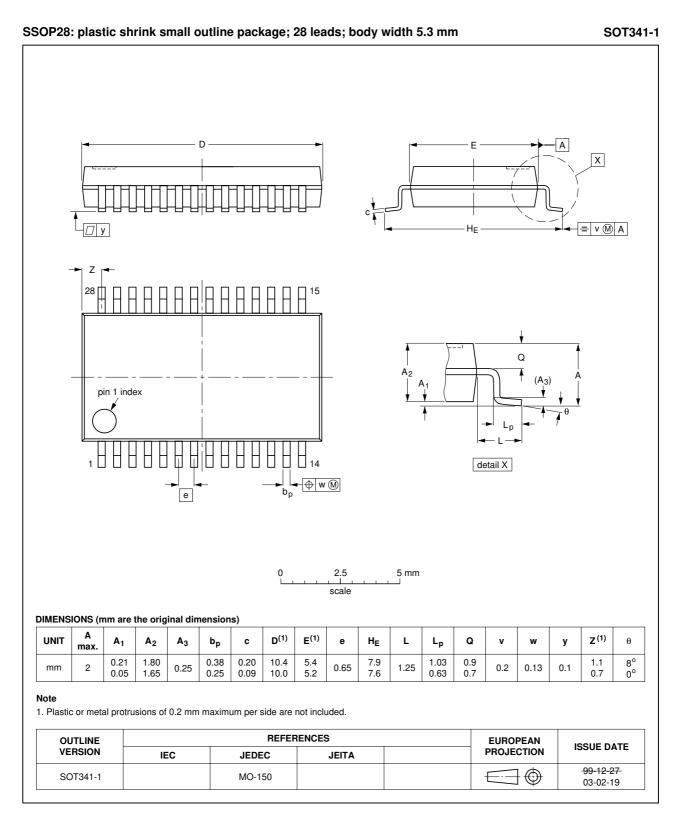


Fig 4. Package outline SSOP28 (SOT134-1)

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13. Revision history

Table 7. Revision his	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
UBA2036TS_1	20081030	Product data sheet	-	-

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14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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